Attorney Docket No.: 100021-00133

AMENDMENTS TO THE CLAIMS

Listing of the claims:

Following is a listing of all claims in the present application, which listing

supersedes all previously presented claims:

1. (Currently Amended) A semiconductor integrated circuit device

comprising:

a high-threshold N-channel type MIS field effect transistor connected between a

real high-potential power supply line and a pseudo high-potential power supply line; and

a load circuit having a low-threshold P-channel type MIS field effect transistor

and a low-threshold N-channel type MIS field effect transistor, wherein:

a first power supply terminal of said load circuit is connected to said

pseudo high-potential power supply line, and a second power supply terminal of said

load circuit is connected to a real low-potential power supply line; and

a back gate of said low-threshold P-channel type MIS field effect transistor

is connected to said pseudo high-potential power supply line, and a back gate of said

low-threshold N-channel type MIS field effect transistor is connected to said real low-

potential power supply line.

2. (Cancelled)

3. (Currently Amended) The semiconductor integrated circuit device as

claimed in claim 1, further comprising:

Attorney Docket No.: 100021-00133

a waveshaping circuit which receives a control signal for controlling said high-

threshold N-channel type MIS field effect transistor, and performs waveshaping so that

an output signal of said waveshaping circuit rises slowly compared to said control signal

rises slowly, and wherein:

said an output signal of said waveshaping circuit is supplied to a gate of

said high-threshold N-channel type MIS field effect transistor.

4. (Original) The semiconductor integrated circuit device as claimed in claim

3, wherein said high-threshold N-channel type MIS field effect transistor is configured as

a source follower, and a voltage on said pseudo high-potential power supply line

connected to the source of said high-threshold N-channel type MIS field effect transistor

rises slowly in response to the slowly rising output signal of said waveshaping circuit

supplied to said gate.

5. (Original) The semiconductor integrated circuit device as claimed in claim

3, wherein said waveshaping circuit comprises a high-threshold final-stage MIS field

effect transistor having a large gate length and a small gate width, or a plurality of high-

threshold final-stage MIS field effect transistors connected in series.

6. (Original) The semiconductor integrated circuit device as claimed in claim

3, wherein said waveshaping circuit comprises a digital/analog converter.

7. (Original) The semiconductor integrated circuit device as claimed in claim

6, wherein said load circuit comprises a memory circuit, and said digital/analog

Attorney Docket No.: 100021-00133

converter outputs a voltage that is lower than a normal operating voltage of said

memory and that only guarantees the retention of stored contents, thereby achieving a

reduction in backup standby power consumption.

8. (Currently Amended) A semiconductor integrated circuit device

comprising:

a high-threshold N-channel type MIS field effect transistor connected between a

real high-potential power supply line and a pseudo high-potential power supply line, said

high-threshold N-channel type MIS field effect transistor being controlled by receiving a

slowly rising control signal to a gate thereof; and

a load circuit having a low-threshold P-channel type MIS field effect transistor

and a low-threshold N-channel type MIS field effect transistor, wherein:

a first power supply terminal of said load circuit is connected to said

pseudo high-potential power supply line, and a second power supply terminal of said

load circuit is connected to a real low-potential power supply line; and

a back gate of said low-threshold P-channel type MIS field effect transistor

is connected to said pseudo high-potential power supply line, and a back gate of said

low-threshold N-channel type MIS field effect transistor is connected to said real low-

potential power supply line.

9. (Currently Amended) A semiconductor integrated circuit device

comprising:

a high-threshold MIS field effect transistor of a first conductivity type, connected

between a first real power supply line and a first pseudo power supply line;

Attorney Docket No.: 100021-00133

a load circuit having a low-threshold MIS field effect transistor of said first conductivity type and a low-threshold MIS field effect transistor of a second conductivity type; and

a level conversion circuit which receives a control signal of a first level for controlling said high-threshold MIS field effect transistor of said first conductivity type, and which converts said control signal of said first level into a control signal of a second level and supplies said control signal of said second level to a gate of said high-threshold MIS field effect transistor of said first conductivity type; and

a waveshaping circuit which receives the output signal of said level conversion circuit, and performs waveshaping so that the output signal of said level conversion circuit rises slowly, wherein:

a first power supply terminal of said load circuit is connected to said first pseudo power supply line, and a second power supply terminal of said load circuit is connected to a second real power supply line; and

an output signal of said waveshaping circuit is supplied to the gate of said high-threshold MIS field effect transistor of said first conductivity type.

- 10. (Original) The semiconductor integrated circuit device as claimed in claim 9, wherein said high-threshold MIS field effect transistor of said first conductivity type and said level conversion circuit are together constructed as a module.
- 11. (Original) The semiconductor integrated circuit device as claimed in claim 9, wherein said first level is equal to a signal interface level of said load circuit, and said second level is a level greater than said first level.

Attorney Docket No.: 100021-00133

12. (Original) The semiconductor integrated circuit device as claimed in claim

9, wherein said first real power supply line is a real high-potential power supply line, said

second real power supply line is a real low-potential power supply line, said first pseudo

power supply line is a pseudo high-potential power supply line, and said high-threshold

MIS field effect transistor of said first conductivity type is a high-threshold N-channel

type MIS field effect transistor, wherein:

a drain of said high-threshold N-channel type MIS field effect transistor is

connected to said real high-potential power supply line, a source thereof is connected to

said pseudo high-potential power supply line, and a back gate thereof is connected to

said real low-potential power supply line.

13. (Original) The semiconductor integrated circuit device as claimed in claim

9, wherein said first real power supply line is a real high-potential power supply line, said

second real power supply line is a real low-potential power supply line, said first pseudo

power supply line is a pseudo high-potential power supply line, and said high-threshold

MIS field effect transistor of said first conductivity type is a high-threshold P-channel

type MIS field effect transistor, wherein:

a source and back gate of said high-threshold P-channel type MIS field

effect transistor are connected to said real high-potential power supply line, and a drain

thereof is connected to said pseudo high-potential power supply line.

14. (Currently Amended) The semiconductor integrated circuit device as

claimed in claim 9, further comprising:

Attorney Docket No.: 100021-00133

a waveshaping circuit which receives the output signal of said level conversion

circuit, and performs waveshaping so that an output signal of said waveshaping circuit

the output signal of said level conversion circuit rises slowly as compared to said output

signal of said level conversion circuit, and wherein:

said an output signal of said waveshaping circuit is supplied to a gate of

said high-threshold MIS field effect transistor of said first conductivity type.

15. (Currently Amended) The semiconductor integrated circuit device as

claimed in claim 14, wherein said high-threshold MIS field effect transistor of said first

conductivity type is configured as a source follower, and a voltage on said first pseudo

power supply line connected to the source of said high-threshold MIS field effect

transistor of said first conductivity type rises slowly in response to the slowly rising

output signal of said waveshaping circuit supplied to said gate.

16. (Original) The semiconductor integrated circuit device as claimed in claim

9, wherein a physical shield is provided over a signal wiring line from said level

conversion circuit to said high-threshold MIS field effect transistor of said first

conductivity type.

17. (Original) The semiconductor integrated circuit device as claimed in claim

16, wherein said semiconductor integrated circuit device has a multilayered wiring

structure, and said shield is formed in a prescribed intermediate wiring layer, while a

signal line of a signal interface level of said load circuit is formed in a wiring layer

RPP/100595.1 -7-

Attorney Docket No.: 100021-00133

located above said prescribed intermediate wiring layer.

18. (Original) The semiconductor integrated circuit device as claimed in claim 14, wherein said waveshaping circuit comprises a high-threshold final-stage MIS field effect transistor having a large gate length and a small gate width, or a plurality of high-threshold final-stage MIS field effect transistors connected in series.

- 19. (Original) The semiconductor integrated circuit device as claimed in claim14, wherein said waveshaping circuit comprises a digital/analog converter.
- 20. (Original) The semiconductor integrated circuit device as claimed in claim 19, wherein said load circuit comprises a memory circuit, and said digital/analog converter outputs a voltage that is lower than a normal operating voltage of said memory and that only guarantees the retention of stored contents, thereby achieving a reduction in backup standby power consumption.

21.-22. (Cancelled)

- 23. (New) The semiconductor integrated circuit device as claimed in claim1, wherein said pseudo high-potential power supply line is brought outside a chip.
- 24. (New) The semiconductor integrated circuit device as claimed in claim 1, wherein said real high-potential power supply line is brought outside a chip.

Attorney Docket No.: 100021-00133

25. (New) The semiconductor integrated circuit device as claimed in claim 8, wherein said pseudo high-potential power supply line is brought outside a chip.

- 26. (New) The semiconductor integrated circuit device as claimed in claim 8, wherein said real high-potential power supply line is brought outside a chip.
- 27. (New) The semiconductor integrated circuit device as claimed in claim 9, wherein said pseudo high-potential power supply line is brought outside a chip.
- 28. (New) The semiconductor integrated circuit device as claimed in claim 9, wherein said real high-potential power supply line is brought outside a chip.